

IN THE CLAIMS

Please amend the claims as follows:

1. (Currently Amended) A memory device comprising:
a plurality of banks, each bank including a plurality of blocks of memory cores, the plurality of banks arranged in a plurality of rows and columns, each row including a blocks of memory cores from a first memory bank and blocks of memory cores from a second memory bank, the blocks from the first and second banks being interleaved in each row in an alternating fashion;
a plurality of sense amplifiers shared between blocks of ~~among~~ memory cores of the first memory bank and the second memory bank ~~different ones of the plurality of banks; and wherein the blocks of~~ memory cores from the first bank and the second bank ~~two of the different ones of the plurality of banks~~ are interleaved in a strip along each row with the plurality of shared sense amplifiers.
2. (Previously Presented) The memory device of claim 1 wherein the column decode conductors traverse the memory cores in the strip.
3. (Original) The memory device of claim 2 further comprising sense nodes substantially parallel to the column decode conductors.
4. (Original) The memory device of claim 1 wherein the plurality of memory cores are arranged into a plurality of strips, each strip including interleaved memory cores from two different ones of the plurality of banks.
5. (Currently Amended) A memory device comprising:
a plurality of memory cores logically arranged into a plurality of banks with each memory core assigned to a unique one of the memory banks and the memory cores arranged into

a plurality of rows and columns with each column being populated with memory cores of the plurality of banks;

a plurality of sense amplifiers, each sense amplifier being shared among between two unique memory cores of two of the plurality of banks along each of the rows; and

wherein the memory cores ~~of the two~~ of the plurality of banks are arranged in a strip in an alternating fashion of banks between ones of the plurality of sense amplifiers across each column.

6. (Previously Presented) The memory device of claim 5 further comprising column decode conductors for the strip, the column decode conductors for the strip being coupled to the plurality of sense amplifiers shared among the memory cores of the two of the plurality of banks.

7. (Previously Presented) The memory device of claim 5 wherein the plurality of memory cores are arranged in a plurality of first strips which correspond to the strip and a plurality of second strips arranged perpendicular to the first strips, each of the plurality of first strips including interleaved memory cores from two different ones of the plurality of banks.

8. (Previously Presented) The memory device of claim 5 wherein the plurality of memory cores are arranged in a plurality of first strips and a plurality of second strips arranged perpendicular to the first strips, each of the plurality of first strips including interleaved memory cores from two different ones of the plurality of banks.

9. (Currently Amended) A memory device comprising:
a first bank of memory cores arranged in a linear strip;
a second bank of memory cores interleaved with the first bank of memory cores arranged in the linear strip; and
a plurality of sense amplifiers shared between memory cores of the first bank and memory cores of the second bank along the linear strip the strip comprising a row populated with only memory cores from the first and second banks.

10. (Previously Presented) The memory device of claim 9 further comprising a plurality of memory cores arranged as horizontal strips and a plurality of memory cores of vertical strips arranged perpendicular to the horizontal strips, wherein the linear strip is one of the plurality of horizontal strips.
11. (Previously Presented) The memory device of claim 10 wherein each of the plurality of horizontal strips includes interleaved memory cores from two different banks.
12. (Original) The memory device of claim 9 wherein each of the plurality of sense amplifiers is coupled to one memory core of the first bank and one memory core of the second bank.
13. (Canceled)
14. (Original) A memory device comprising:
a first bank of memory cores arranged in a strip;
a second bank of memory cores interleaved with the first bank of memory cores arranged in the strip;
a plurality of sense amplifiers shared between memory cores of the first bank and memory cores of the second bank; and
a column decoder arranged to drive column decode lines coupled to the plurality of sense amplifiers.
15. (Previously Presented) The memory device of claim 14 further comprising a plurality of memory cores arranged in horizontal strips and a plurality of memory cores arranged in vertical strips arranged perpendicular to the horizontal strips, wherein the strip is one of the plurality of horizontal strips.
16. (Previously Presented) The memory device of claim 15 wherein each of the plurality of horizontal strips includes interleaved memory cores from two different banks.

17. (Original) The memory device of claim 14 wherein each of the plurality of sense amplifiers is coupled to one memory core of the first bank and one memory core of the second bank.
18. (Currently Amended) An integrated circuit comprising:
an array of memory cores ~~having~~ arranged as rows along a first dimension and arranged as columns along a second dimension; and
wherein a strip of memory cores in the first dimension includes memory cores from a first bank interleaved with memory cores from a second bank interspersed with shared sense amplifiers between memory cores of different banks.
19. (Previously Presented) The integrated circuit of claim 18 wherein the first dimension includes a plurality of horizontal strips of memory cores, and the second dimension includes a plurality of vertical strips of memory cores, and each of the plurality of horizontal strips includes interleaved memory cores from two different banks.
20. (Previously Presented) The integrated circuit of claim 19 wherein each of the plurality of vertical strips includes non-interleaved memory cores from different banks.
21. (Original) The integrated circuit of claim 18 further comprising:
a column decoder; and
a plurality of column decode conductors driven by the column decoder and situated substantially parallel to the strip of memory cores.
22. (Original) An integrated circuit comprising:
an array of memory cores having a first dimension and a second dimension, wherein a strip of memory cores in the first dimension includes memory cores from a first bank interleaved with memory cores from a second bank; and

a plurality of sense amplifiers arranged between memory cores from the first bank and memory cores from the second bank.

23. (Previously Presented) The integrated circuit of claim 22 wherein:
the first dimension includes a plurality of horizontal strips of memory cores;
the second dimension includes a plurality of vertical strips of memory cores; and
each of the plurality of horizontal strips includes interleaved memory cores from two different banks.

24. (Previously Presented) The integrated circuit of claim 23 wherein each of the plurality of vertical strips includes non-interleaved memory cores from different banks.

25. (Original) The integrated circuit of claim 22 further comprising:
a column decoder; and
a plurality of column decode conductors driven by the column decoder, coupled to the plurality of sense amplifiers, and situated substantially parallel to the strip of memory cores.

26. (Original) An integrated circuit comprising:
an array of memory cores having a first dimension and a second dimension, wherein a strip of memory cores in the first dimension includes memory cores from a first bank interleaved with memory cores from a second bank;
a plurality of sense amplifiers arranged between memory cores from the first bank and memory cores from the second bank; and
column decode conductors coupled to the plurality of sense amplifiers, the column decode conductors arranged to be near memory cores of the first and second bank, and not near memory cores of other banks.

27. (Previously Presented) The integrated circuit of claim 26 wherein the first dimension includes a plurality of horizontal strips of memory cores, and the second dimension

includes a plurality of vertical strips of memory cores, and each of the plurality of horizontal strips includes interleaved memory cores from two different banks.

28. (Previously Presented) The integrated circuit of claim 27 wherein each of the plurality of vertical strips includes non-interleaved memory cores from different banks.

29. (Previously Presented) A memory device comprising:
a first bank of memory cores;
a second bank of memory cores; and
a plurality of sense amplifiers shared between the first bank of memory cores and the second bank of memory cores;
wherein the first bank of memory cores and the second bank of memory cores are interleaved in a first horizontal strip on the memory device.

30. (Previously Presented) The memory device of claim 29 further comprising:
a plurality of horizontal strips of which the first horizontal strip is one; and
a plurality of vertical strips of memory cores, each of the plurality of vertical strips of memory cores having non-interleaved memory cores from a plurality of banks.

31. (Previously Presented) The memory device of claim 29 further comprising:
a third bank of memory cores;
a fourth bank of memory cores; and
a plurality of sense amplifiers shared between the third bank of memory cores and the fourth bank of memory cores;
wherein the third bank of memory cores and the fourth bank of memory cores are interleaved in a second horizontal strip parallel to the first horizontal strip.

32. (Original) The memory device of claim 29 further comprising pass transistors coupled to the plurality of sense amplifiers to select data from either the first bank of memory cores or the second bank of memory cores.

33. (Previously Presented) A memory device comprising:
a first bank of memory cores;
a second bank of memory cores, wherein the first bank of memory cores and the second bank of memory cores are interleaved in a first horizontal strip on the memory device;
a plurality of sense amplifiers shared between the first bank of cores and the second bank of cores;
a column decoder; and
a plurality of column decode conductors coupled to the column decoder and the plurality of sense amplifiers, the plurality of column decode conductors being substantially parallel to the first horizontal strip on the memory device.
34. (Previously Presented) The memory device of claim 33 further comprising:
a plurality of horizontal strips of which the first horizontal strip is one; and
a plurality of vertical strips of memory cores, each of the plurality of vertical strips of memory cores having non-interleaved memory cores from a plurality of banks.
35. (Previously Presented) The memory device of claim 33 further comprising:
a third bank of memory cores;
a fourth bank of memory cores; and
a plurality of sense amplifiers shared between the third bank of memory cores and the fourth bank of memory cores;
wherein the third bank of memory cores and the fourth bank of memory cores are interleaved in a second horizontal strip parallel to the first horizontal strip.
36. (Previously Presented) A memory device comprising:
a plurality of memory cores physically arranged in horizontal strips and vertical strips and logically arranged into banks that share sense amplifiers, wherein memory cores arranged in a first horizontal strip alternate between a first bank and a second bank.

37. (Original) The memory device of claim 36 further comprising:
a column decoder;
column decode conductors coupled between the column decoder and the sense amplifiers shared between the first bank and the second bank; and
sense nodes coupled to the sense amplifiers, arranged substantially parallel to the column decode conductors.
38. (Previously Presented) The memory device of claim 36 wherein memory cores in a second horizontal strip are arranged to alternate between a third bank and a fourth bank.
39. (Previously Presented) The integrated circuit of claim 36 wherein each of the of vertical strips includes non-interleaved memory cores from different banks.
40. (Previously Presented) A memory device comprising:
a plurality of memory cores physically arranged in horizontal strips and vertical strips and logically arranged into banks that share sense amplifiers, wherein memory cores arranged in a first horizontal strips alternate between a first bank and a second bank; and
column decode conductors arranged in the first horizontal strip to cross memory cores from the first bank and the second bank.
41. (Previously Presented) The memory device of claim 40 further comprising:
a second horizontal strip having interleaved memory cores from a third bank and a fourth bank; and
a second plurality of sense amplifiers shared between the third bank and the fourth bank.
42. (Previously Presented) The memory device of claim 40 wherein each of the vertical strips includes non-interleaved memory cores from different banks.

43. (Previously Presented) A memory device comprising:
a plurality of memory cores physically arranged in a plurality of horizontal strips and a plurality of vertical strips and logically arranged into banks;
wherein memory cores arranged in each of the plurality of horizontal strips alternate between two banks, and memory cores arranged in each of the plurality of vertical strips are from a different bank.
44. (Previously Presented) The memory device of claim 43 further comprising sense amplifiers shared between memory cores in each of the plurality of horizontal strips.
45. (Previously Presented) The memory device of claim 44 further comprising column decode conductors dedicated to each horizontal strip, each column decoder conductor passing over memory cores of two banks and no more.
46. (Previously Presented) A computer system comprising:
a processor; and
a memory device coupled to the processor, the memory device including:
a plurality of horizontal strips and vertical strips of memory cores; and
a plurality of sense amplifiers positioned between memory cores within each horizontal strip, wherein every other memory core within each horizontal strip is assigned to a bank.
47. (Original) The computer system of claim 46 wherein each sense amplifier is shared between two banks.
48. (Original) The computer system of claim 46 further comprising a memory controller coupled to the processor and the memory device.
49. (Previously Presented) A computer system comprising:
a processor; and

a memory device coupled to the processor, the memory device including:

- a first bank of memory cores arranged in a first horizontal strip;
- a second bank of memory cores interleaved with the first bank of memory cores in the first horizontal strip;
- a third bank of memory cores arranged in a second horizontal strip; and
- a fourth bank of memory cores interleaved with the third bank of memory cores in the second horizontal strip.

50. (Original) The computer system of claim 49 wherein the memory device further includes:

- a first plurality of sense amplifiers shared between the first bank of memory cores and the second bank of memory cores; and

- a second plurality of sense amplifiers shared between the third bank of memory cores and the fourth bank of memory cores.

51. (Original) The computer system of claim 49 further comprising a memory controller coupled to the processor and the memory device.

52. (Original) A computer system comprising:

- a processor; and

- a memory coupled to the processor, the memory including:

- a plurality of sense amplifiers;

- a first bank of memory cores, each coupled to at least one of the plurality of sense amplifiers; and

- a second bank of memory cores, each coupled to at least one of the plurality of sense amplifiers;

- wherein the first bank of memory cores and the second bank of memory cores are arranged in a strip with the plurality of sense amplifiers.

53. (Original) The computer system of claim 52 wherein the memory further includes:
column decode conductors coupled to the plurality of sense amplifiers and
a column decoder to drive the column decode conductors.
54. (Original) The computer system of claim 52 further comprising a memory controller
coupled to the processor and the memory device.
55. (Previously Presented) A computer system comprising:
a processor;
a memory controller coupled to the processor; and
a memory device coupled to the memory controller, the memory device including:
a plurality of memory cores logically arranged into Rambus-compatible banks and
physically arranged into horizontal strips and vertical strips, wherein each vertical strip includes
interleaved memory cores from two different Rambus-compatible banks.
56. (Previously Presented) The computer system of claim 55 wherein the memory
device includes sense amplifiers shared between memory cores of Rambus-compatible banks in
each horizontal strip.
57. (Previously Presented) A multibank memory device allowing simultaneous access
of some of a plurality of memory banks while suffering reduced noise in sense amplifiers,
comprising:
a plurality of memory banks, each memory bank including a plurality of memory cores
arranged in strips of horizontal strips and vertical strips;
a plurality of sense amplifiers shared among the memory cores of different ones of the
plurality of memory banks;
a plurality of column decoders, each column decoder exclusively accessing a horizontal
strip of memory cores from only two of the plurality of memory banks wherein the memory
cores are separated from each other in the horizontal strip by shared sense amplifiers whereby
the memory cores of the horizontal strip alternate between the two memory banks.

58. (Previously Presented) A memory architecture having n banks of memory banks which allows simultaneous access of some of the memory banks, comprising a plurality of memory banks, each memory bank including a plurality of memory cores arranged in horizontal strips, each horizontal strip having an associated column decoder connected to each memory core of the horizontal strip and each core of the horizontal strip associated with only one of two memory banks.

59. (Previously Presented) A multibank memory architecture allowing simultaneous access of some of a plurality of memory banks while suffering reduced noise in sense amplifiers, comprising:

a plurality of memory banks, each memory bank containing a plurality of memory cores arranged in strips, each strip containing two memory banks and the strip having cores arranged to be alternating between the two memory banks with sense amplifiers shared between the cores of the two memory banks.

60. (Previously Presented) A multibank memory architecture allowing simultaneous access of some of a plurality of memory banks comprising a horizontal strip of memory cores interspersed between shared sense amplifiers, each memory core being a part of one of N memory banks, the strip having the memory cores laid out so that no two memory cores of the same memory bank share a common sense amplifier.